

Dear DEED Community,

My apologies for overlooking two items that needed to be sent out this month— but which I missed in the Sept newsletter sent last week. They are items 4 and 5 in the Table of Contents

The intent of this newsletter is to inform the DEED community about upcoming events and related news in DEED, ASEE, and the engineering design community. As always, these newsletters and even more awesome information are available 24 hours a day, 7 days a week, at locations all around the world on our [DEED website](#).

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1) Call for Papers —> Abstracts accepted until October 16, 2016

DEED call for papers: http://deed.asee.org/wp-content/uploads/2016/08/DEED_ASEE2017_CallForPapers.pdf
DEED guidelines for submissions (NEW!): http://deed.asee.org/wp-content/uploads/2016/08/DEED_ASEE2017_PaperGuidelines.pdf

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2) Major schedule changes for ASEE 2016 in Columbus

- More technical sessions – starting on Sunday at 8:00 am (no more workshops on Sunday)
- Workshops moved to Wednesday afternoon (2 hour or 4 hour)
 - Technical sessions are run concurrent with workshops
- Exclusive business meeting block – Tuesday June 27 5:00-6:00 pm
- Distinguished Lectures on Wed 9:45-11:15 am
- No technical sessions from 7:00-8:30 p.m. on Monday or Tuesday. These time slots are reserved for social events, as was the practice in previous years.

More details are available [here](#).

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3) 7th IEEE Integrated STEM Education Conference (ISEC '17)

March 11, 2017, Friend Center, Princeton University

- Submissions open: October 16, 2016 (the direct link for submissions is edas.info/N22730)
- Submissions closed: 11:59 pm EST December 18, 2016

- Acceptances sent: January 15, 2017
- Final revisions due: February 5, 2017
- Early registration deadline: February 28, 2017

ISEC is known for presenting cutting-edge research in and experiences with integrated approaches to the study of science, math, and technology through experiences and activities based in engineering and other design disciplines.

Please visit us at ewh.ieee.org/conf/stem for information on paper format requirements, fees, and other conference information; follow us on Twitter @IEEE_ISEC; and like us on Facebook. Contact us at ieee.isec@gmail.com for more information. We look forward to your participation in ISEC 2017!

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4) International Symposium on Academic Makerspaces (ISAM)

November 13-16,2016 – MIT - Cambridge, MA

Registration is now open for the first International Symposium on Academic Makerspaces. The symposium will be a gathering of leaders from institutions that have, and are considering having, a makerspace on campus. The meeting will feature keynote addresses, presented papers, panel discussions, vendor interactions, and video presentations to advance the dialog on and share best practices associated with higher education makerspaces. Information is available at <http://project-manus.mit.edu/home/conference> .

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5) Department of Engineering at James Madison University Invites Applications for Two Tenure Track Assistant Professor Positions

The Department of Engineering at James Madison University invites applicants who strive to be world-class engineering educators for two open tenure-track Assistant Professor positions to start in August 2017. We are seeking two colleagues with experience in the engineering application of modeling, data science, risk analysis; resilient built and natural infrastructure systems; or related areas. Successful applicants will be able to teach throughout our undergraduate curriculum and will be expected to develop collaborative, cross-cutting and transformative scholarship and student mentoring opportunities that complement or bridge ongoing engineering endeavors. We value excellence in innovative, evidence-based undergraduate teaching, as well as engaging undergraduate students through project and research experiences. Compelling candidates will capitalize on university-wide initiatives such as ethical reasoning; creativity, innovation, and entrepreneurship; community and civic engagement; and sustainability. A Ph.D. in any engineering discipline or related field is required. Experience outside academia is strongly desirable.

Salary is commensurate with experience. Applications are being accepted immediately, and review will begin on November 7, 2016. Applications will be accepted and reviewed until the position is filled, contingent on state authorization. For additional information and to apply, visit [https:// JobLink.jmu.edu](https://JobLink.jmu.edu) and search for posting number (Posting 0407647). Only completed submissions that are uploaded electronically to the JMU JobLink system will be considered.

James Madison University is an equal opportunity employer committed to creating and supporting a diverse and inclusive work and educational community that is free of all forms of discrimination.

If you have any questions regarding the position, please contact: Dr. Justin Henriques, (henricjj@jmu.edu), Search Committee Chair, or Dr. Kurt Paterson (paterskg@jmu.edu), Department Head.

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6) Submitting to the InDEED Newsletter

To submit an item to the InDEED newsletter, please prepare a short description (no more than 2 paragraphs) including any relevant URLs (in explicit form, not as hyperlinks), deadlines and contact information.

Putting the words "DEED newsletter" in the subject will help make sure your submission makes it in the email.

Email this information to Reid Bailey, DEED Division Chair - rbailey@virginia.edu

The newsletter will be distributed around the 15th of each month. Newsletter submissions should be sent no later than the 10th of the month.

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Reid Bailey
DEED Chair 2016-2017